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## FDP5500-F085

## **N-Channel UltraFET Power MOSFET**

**55V, 80A, 7m**Ω

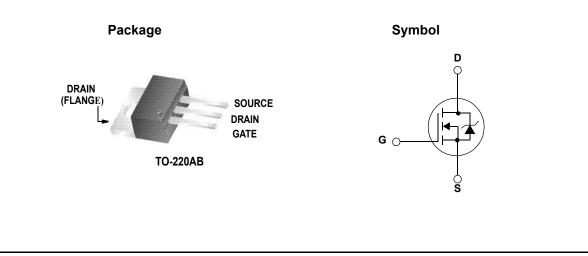
## Features

- Typ  $r_{DS(on)}$  = 5.1m $\Omega$  at V<sub>GS</sub> = 10V, I<sub>D</sub> = 80A
- Typ  $Q_{g(10)}$  = 114nC at  $V_{GS}$  = 10V
- Simulation Models
- -Temperature Compensated PSPICE and SABER<sup>TM</sup> Models
- Peak Current vs Pulse Width Curve
- UIS Rating Curve
- Qualified to AEC Q101
- RoHS Compliant

## Applications

- DC Linear Mode Control
- Solenoid and Motor Control
- Switching Regulators
- Automotive Systems





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Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain to Source Voltage	(Note 1)	55	V
V <sub>DGR</sub>	Drain to Gate Voltage ( $R_{GS}$ = 20k $\Omega$ )	(Note 1)	55	V
V <sub>GS</sub>	Gate to Source Voltage		±20	V
	Drain Current Continuous (T <sub>C</sub> < 135 <sup>o</sup> C, V <sub>GS</sub> = 10V)		80	Α
D	Pulsed		See Figure 4	A
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	860	mJ
П	Power Dissipation		375	W
P <sub>D</sub>	Derate above 25°C		2.5	W/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to + 175	
ΤL	Max. Lead Temp. for Soldering (at 1.6mm from case for 10sec)		300	°C
T <sub>pkg</sub>	Max. Package Temp. for Soldering (Package Body for 10sec)		260	

## **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance Junction to Case	0.4	°C/W
$R_{\thetaJA}$	Thermal Resistance Junction to Ambient TO-220AB, 1in <sup>2</sup> copper pad area	62	°C/W

## Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDP5500	FDP5500-F085	TO-220AB	Tube	N/A	50 units

# **Electrical Characteristics** $T_{C}$ = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
	restariation					

## Off Characteristics

B <sub>VDSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0\	/	55	-	-	V
1	Zero Gate Voltage Drain Current	$V_{DS} = 50V, V_{GS} = 0^{10}$	V	-	-	1	
DSS	Zero Gale Vollage Drain Current	V <sub>DS</sub> = 45V	$T_{C} = 150^{\circ}C$	-	-	250	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS}$ = ±20V		-	-	±100	nA

#### **On Characteristics**

V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2	2.8	4	V
r <sub>DS(on)</sub>	Drain to Source On Resistance	I <sub>D</sub> = 80A, V <sub>GS</sub> = 10V	-	5.1	7	mΩ

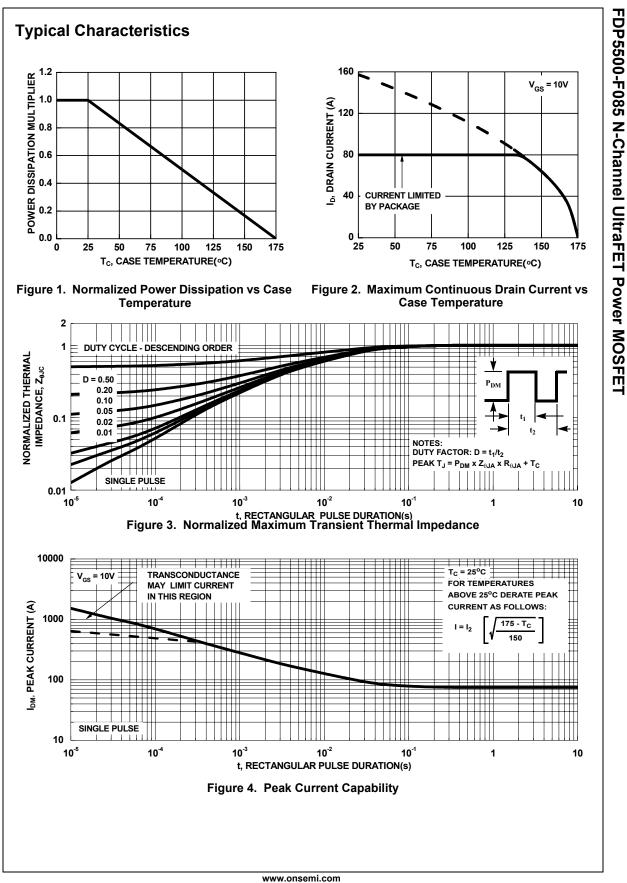
### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance		0) (	-	3565	-	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 25V, V <sub>GS</sub> = f = 1MHz	UV,	-	1310	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			-	395	-	pF
Q <sub>g(TOT)</sub>	Total Gate Charge at 20V	V <sub>GS</sub> = 0 to 20V		-	207	269	nC
Q <sub>g(10)</sub>	Total Gate Charge at 10V	V <sub>GS</sub> = 0 to 10V	$V_{DD} = 30V$	-	114	148	nC
Q <sub>g(TH)</sub>	Threshold Gate Charge	$V_{GS}$ = 0 to 2V	$I_D = 80A$ $R_1 = 0.4\Omega$	-	6.6	8.6	nC
Q <sub>gs</sub>	Gate to Source Gate Charge		$R_{L} = 0.452$ $I_{g} = 1.0 \text{mA}$	-	17.2	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		9	-	52	-	nC

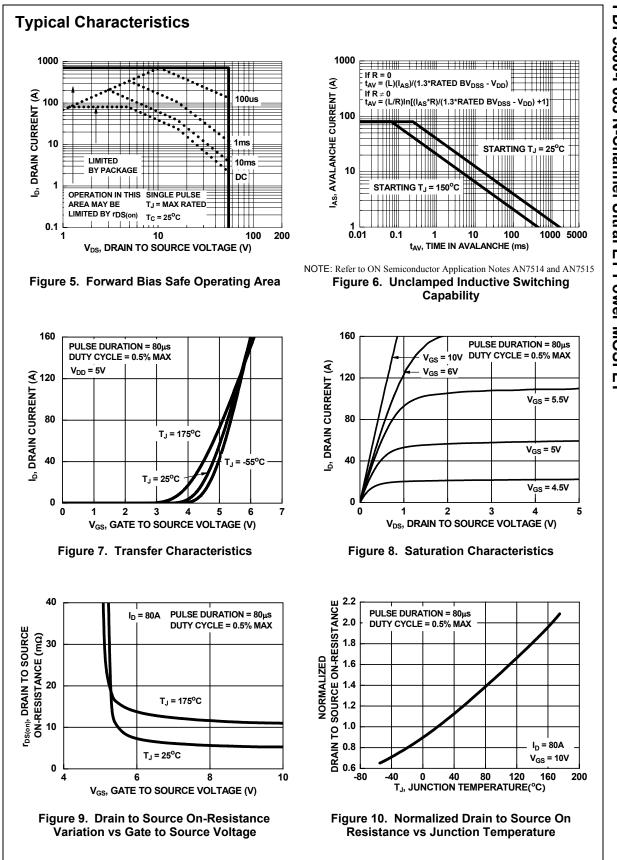
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Switch	ing Characteristics					
t <sub>on</sub>	Turn-On Time	$V_{DD}$ = 30V, I <sub>D</sub> = 80A, $R_L$ = 0.4Ω, V <sub>GS</sub> = 10V, $R_{GS}$ = 2.5Ω	-	-	75	ns
t <sub>d(on)</sub>	Turn-On Delay Time		-	12	-	ns
t <sub>r</sub>	Rise Time		-	34	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	37	-	ns
t <sub>f</sub>	Fall Time		-	23	-	ns
t <sub>off</sub>	Turn-Off Time		-	-	96	ns
Drain-So V <sub>SD</sub>	ource Diode Characteristics	I <sub>SD</sub> = 80A	-	0.9	1.25	V
t <sub>rr</sub>	Reverse Recovery Time		-	58	75	ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> = 80A, dI <sub>SD</sub> /dt = 100A/μs	_	71	92	nC

Notes:

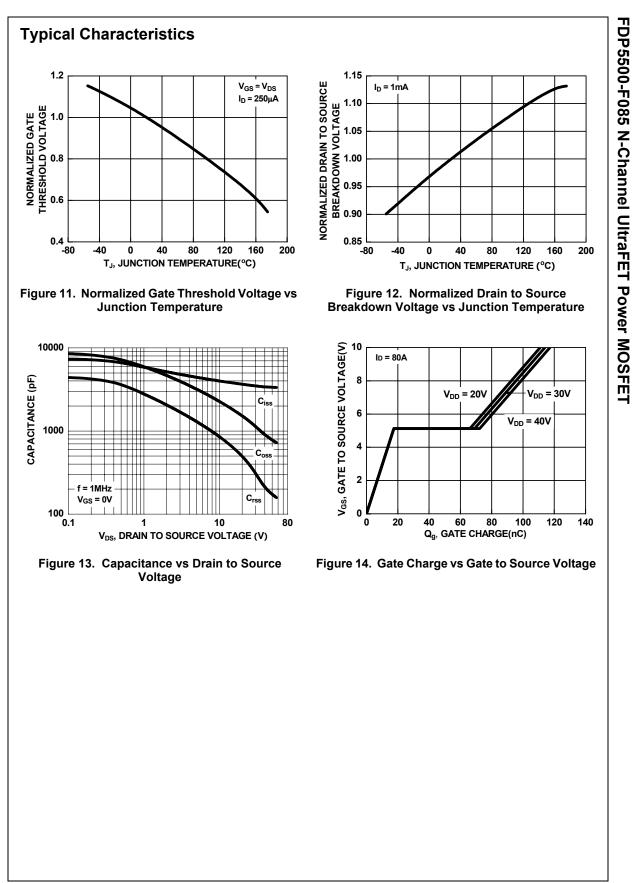
1: Starting  $T_J = 25^{\circ}C \text{ to}175^{\circ}C.$ 2: Starting  $T_J = 25^{\circ}C, L = 0.42\text{mH}, I_{AS} = 64\text{A}$ 



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FDP5500-F085 N-Channel UltraFET Power MOSFET



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